

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2848517

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HANS-DIETER RENKL	09/28/1998
DOUWE MARTEN KOK	09/21/1998
THOMAS JUNKER	09/25/1998
KARL-HEINZ KEIM	09/28/1998
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ACHESON INDUSTRIES, INC.
<b>Street Address:</b>	511 FORT STREET, SUITE 315
<b>City:</b>	PORT HURON
<b>State/Country:</b>	MICHIGAN
<b>Postal Code:</b>	48060
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	10373245
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(860)571-5123
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	860-571-5001
<b>Email:</b>	rhpatentmail@us.henkel.com
<b>Correspondent Name:</b>	HENKEL CORPORATION
<b>Address Line 1:</b>	ONE HENKEL WAY
<b>Address Line 4:</b>	ROCKY HILL, CONNECTICUT 06067
<b>ATTORNEY DOCKET NUMBER:</b>	ACH181
<b>NAME OF SUBMITTER:</b>	STEVEN C. BAUMAN
<b>SIGNATURE:</b>	/stevencbauman/
<b>DATE SIGNED:</b>	05/09/2014
<b>Total Attachments: 1</b>	
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ASSIGNMENT BY INVENTOR(S)

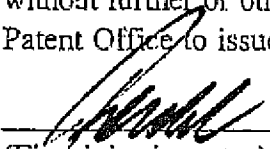
WHEREAS, the undersigned, hereinafter referred to as Assignor(s), have made an invention entitled:

Process and device for preparing the mold walls of a mold for forming and shaping for the next following molding cycle, spray element with centrifugal atomization and air conduction, and the use of such a spray element for spraying basically solvent-free agents.

for which Assignor is about to make Application for Patent; and

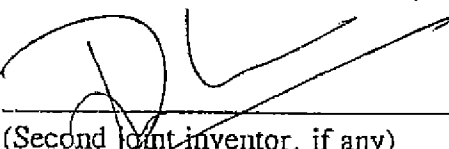
WHEREAS, Acheson Industries, Inc. (a Michigan corporation), 511 Fort Street, Suite 315, Port Huron, Michigan 48060 hereinafter referred to as Assignee(s), is (are) desirous of acquiring an interest therein:

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, Assignor(s) by these presents does sell, assign and transfer unto Assignee(s), its successors in interest, the full and exclusive right in Germany and in the United States of America and all other foreign countries to the said invention as described in the application executed by Assignors preparatory to obtaining Letters Patent therefor, said invention and all applications for Letters Patent and all Patents therefor to be held and enjoyed by Assignee(s) to the full end of the term for which said Letters Patent are granted and any extensions thereof as fully and entirely as the same would have been held by Assignors had this assignment and sale not been made; and Assignor hereby covenants and agree to execute all instruments or documents required or requested for the making and prosecution of application for Letters Patent of Germany and the United States of America and all foreign countries on, for litigation regarding, or for the purpose of protecting title to the said invention or Letters Patent therefor for the benefit of Assignee(s) without further or other compensation than that above set forth; and Assignors hereby request the Patent Office to issue said Patent to Assignee(s).

  
(First joint inventor)


Date

HANS-DIETER RENKL 28.09.1998  
Printed Name

  
(Second joint inventor, if any)

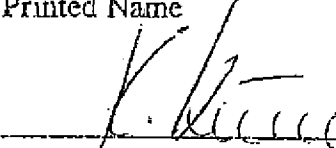
Date

DOUWE MARTEN KDK 21.9.98  
Printed Name

  
(Third joint inventor, if any)

Date

THOMAS JUNKER 25.9.98  
Printed Name

  
(Fourth joint inventor, if any)

Date

KARL-HEINZ KEIM 28.9.98  
Printed Name

(Fifth joint inventor, if any)

Date

(Sixth joint inventor, if any)

Date

**PATENT**